



**VSP1900** 

SLES062 - MARCH 2003

# **CCD VERTICAL DRIVER** FOR DIGITAL CAMERAS

#### **FEATURES**

- CCD Vertical Driver:
  - Two Field CCD Support
- **Output Drivers:** 
  - 3 Levels Driver (V-Transfer) x 5
  - 2 Levels Driver (V-Transfer) x 3
  - 2 Levels Driver (E-Shutter) x 1
- **Drive Capability:** 
  - 450 pF to 1890 pF With 60  $\Omega$  to 240  $\Omega$
- Input Phase:
  - 3 State (V-Transfer) x 5

  - 2 State (E-Shutter) x 1
- **Portable Operation:** 
  - Input Interface: 2.7 V to 5.5 V

## **Power Supply:**

VDD 2.7 V to 5.5 V – VL -5 V to -9 V – VM **GND** 

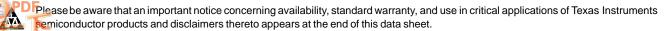
– VH 11.5V to 15.5 V

#### APPLICATIONS

- **Digital Camera**
- Video Camera

## DESCRIPTION

The VSP1900 is a CCD vertical clock driver with electricshutter support. This device is composed of eight vertical transfer channels, which support both 3-field CCD and 2-field CCD operation. The VSP1900 contributes low power consumption and parts number reduction in the system.





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 $These devices have {\it limited built-in ESD protection}. The {\it leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates}.$ 

# **ORDERING INFORMATION**

PRODUCT	PACKAGE	PACKAGE DESIGNATOR	OPERATING TEMPERATURE RANGE	PACKAGE MARKING	ORDERING NUMBER	TRANSPORT MEDIA
V0D4000	TOOODOO	DDT	0500 1- 0500	V0D4000	VOD4000	Tube (60 units/tube)
VSP1900	TSSOP30	DBT	−25°C to 85°C	VSP1900	VSP1900	Tape and reel

<sup>(1)</sup> For the most current specification and package information, refer to our web site at www.ti.com.

## **ABSOLUTE MAXIMUM RATINGS**

over operating free-air temperature range unless otherwise noted(1)

		UNITS
	VDD	GND -0.3 V to 7 V
Supply voltage	VL	GND to –10 V
	VH	VL + 26 V
Input voltage, V <sub>IN</sub>		GND -0.3 V to (VDD + 0.3 V)
Ambient temperature under bias		−25°C to 85°C
Storage temperatu	ire, T <sub>stg</sub>	−55°C to 150°C
Junctiontemperate	150°C	
Package temperat	ure (IR reflow, peak)	235°C

<sup>(1)</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

# RECOMMENDED OPERATING CONDITIONS

free-air temperature range unless otherwise noted

	MIN	NOM	MAX	UNIT
Supply voltage, VDD	2.7		5.5	V
Supply voltage, VL	-5		-9	V
Supply voltage, VH	11.5		15.5	V
Input voltage, VIN		GND – 0.3 to		V
		(VDD + 0.3)		

# **TRUTH TABLE**

	INPUT				OUTPUT	
V1N V3AN V3BN V5AN V5BN	CH1N CH2N CH3N CH4N CH5N	V2N V4N V6N	SUBN	V1 V3A V3B V5A V5B	V2 V4 V6	SUB
L	L	Х	Х	VH	Х	Х
L	Н	Х	Х	VM	Х	Х
Н	L	Х	Х	Z	Х	Х
Н	Н	Х	Х	VL	Х	Х
Х	Х	L	Х	Х	VM	Х
Х	Х	Н	Х	Х	VL	Х
Х	Х	Х	L	Х	Х	VH
Х	Х	Х	Н	Х	Х	VL

NOTE: Z = High impedance

X = Don't care



# **ELECTRICAL CHARACTERISTICS**

all specifications at  $T_A = 25$ °C (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
	DC power consumption			5.3		mW
	Switching power consumption	VSP2267 (TG) with loading diagram		550		mW
DC CHA	RACTERISTICS		•			
VIH	High-level input voltage		0.7VDD			V
VIL	Low-level input voltage				0.2VDD	V
I <sub>IN</sub>	Input current	V <sub>IN</sub> = GND to 5 V (without pullup / pulldown resistor)	-10	0	10	
		V <sub>IN</sub> = GND to 5 V (pullup / pulldown resistor)	-625	0	625	μΑ
lΗ				0.1	0.2	
I <sub>DD</sub>	Operating supply current			1		mA
ΙL				0.125		
loL		V1, V2, V3A, V3B, V4, V5A, V5B, V6 = -8.1 V	10			
I <sub>OM1</sub>		V1, V2, V3A, V3B, V4, V5A, V5B, V6 = -0.2 V			<b>-</b> 5	
I <sub>OM2</sub>		V1, V3A, V3B, V5A, V5B = 0.2 V	5			
ІОН	Output current	V1, V3A, V3B, V5A, V5B = 14.55 V			-7.2	mA
losL		SUB = -8.1 V	5.4			
IOSH		SUB = 14.55 V			-4	

# **SWITCHING CHARACTERISTICS**

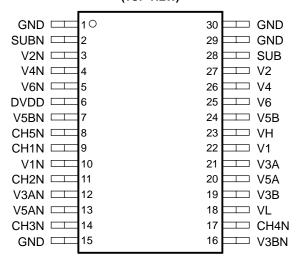
all specifications at  $T_A = 25$ °C (unless otherwise noted)

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
td(PLM)				15	100		
td(PMH)				20	100		
td(PLH)	Drangation delevitims			20	100	20	
td(PML)	Propagation delay time			15	50	ns	
td(PHM)				30	50		
td(PHL)				30	50		
tr(TLM)		$VL \rightarrow VM$			300		
tr(TMH)	Rise time	$VM \rightarrow VH$			300	ns	
tr(TLH)		$VL \rightarrow VH$			300		
t <sub>f</sub> (TML)		$VM \rightarrow VL$			300		
t <sub>f</sub> (THM)	Fall time	$VH \rightarrow VM$			300	ns	
t <sub>f</sub> (THL)		$VH \rightarrow VL$			300		
V <sub>n</sub> (CLH)							
V <sub>n(CLL)</sub>							
V <sub>n</sub> (CMH)	Output noise voltage				2	V	
V <sub>n(CML)</sub>							
V <sub>n</sub> (CHL)							



# **PIN ASSIGNMENTS**

# DBT PACKAGE (TOP VIEW)

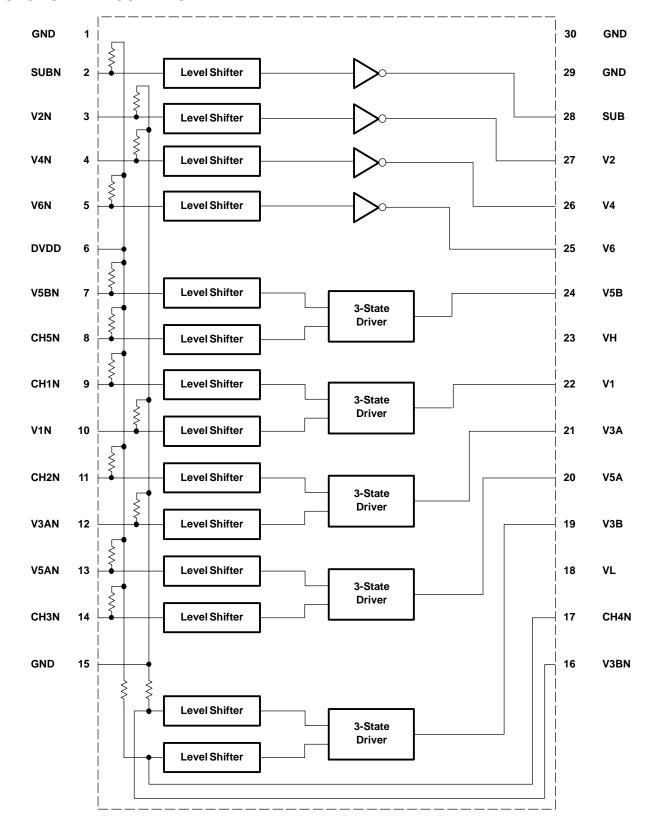


# **Terminal Functions**

TERMII	NAL		
NAME	NO.	TYPE	DESCRIPTIONS
GND	1	Р	Ground
SUBN	2	DI	CCD substrate clock SUB input
V2N	3	DI	Vertical transfer clock 2 input
V4N	4	DI	Vertical transfer clock 4 input
V6N	5	DI	Vertical transfer clock 6 input
DVDD	6	Р	Digital power supply
V5BN	7	DI	Vertical transfer clock 5B input
CH5N	8	DI	Read out clock 5 input
CH1N	9	DI	Read out clock 1 input
V1N	10	DI	Vertical transfer clock 1 input
CH2N	11	DI	Read out clock 2 input
V3AN	12	DI	Vertical transfer clock 3A input
V5AN	13	DI	Vertical transfer clock 5A input
CH3N	14	DI	Read out clock 3 input
GND	15	Р	Ground
V3BN	16	DI	Vertical transfer clock 3B input
CH4N	17	DI	Read out clock 4 input
VL	18	Р	Digital power supply
V3B	19	DO	Vertical transfer clock 3B output
V5A	20	DO	Vertical transfer clock 5A output
V3A	21	DO	Vertical transfer clock 3A output
V1	22	DO	Vertical transfer clock 1 output
VH	23	Р	Digital power supply
V5B	24	DO	Vertical transfer clock 5B output
V6	25	DO	Vertical transfer clock 6 output
V4	26	DO	Vertical transfer clock 4 output
V2	27	DO	Vertical transfer clock 2 output
SUB	28	DO	CCD substrate clock SUB output
GND	29	Р	Ground
GND	30	Р	Ground

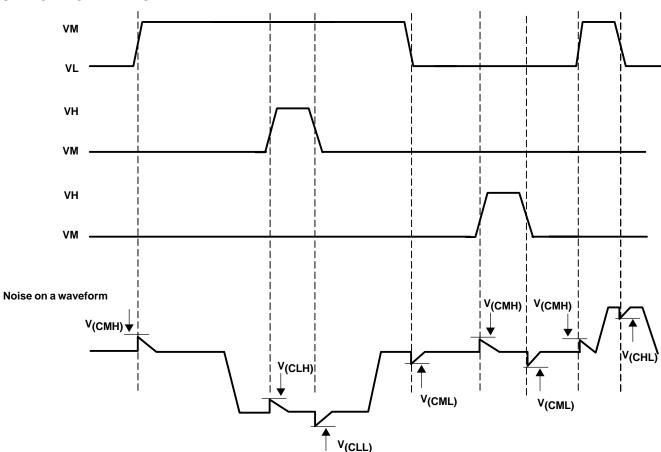


## **FUNCTIONAL BLOCK DIAGRAM**











# **LOADING DIAGRAM**

	R1, R2, R4, R6	60 Ω
Vertical clock series resistor	R3A, R5A	240 Ω
	R3B, R5B	2 08
	СФV1	1280 pF
Vertical sleek to CND	СФV3А, СФV3В	640 pF
Vertical clock to GND	СФV5А, СФV5В	640 pF
	CΦV2, CΦV4, CΦV6	400 pF
	СФV12	510 pF
	СФV23A, СФV23B	50 pF
Between water latests	СФV45А, СФV45В	50 pF
Between vertical clock	СФV3А4, СФV3В4	260 pF
	СФV5A6, СФV5B6	260 pF
	СФV61	100 pF
Substrate clock to GND	СФVSUB	1000 pF
Vertical clock GND resistor	R GND	18 Ω

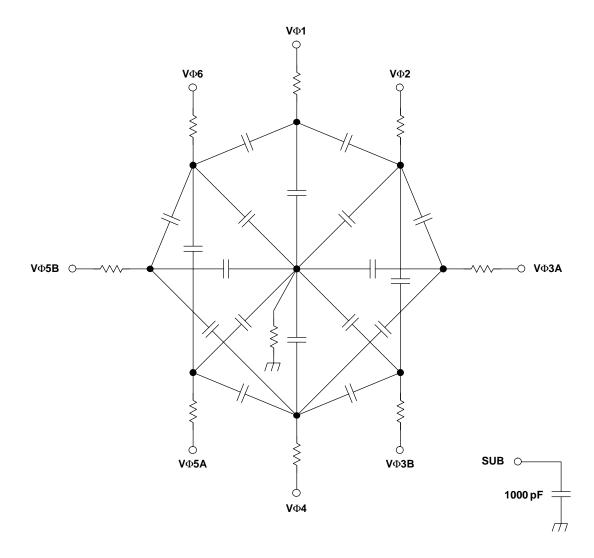


Figure 1. VSP1900 Loading Diagram



#### DESCRIPTION

The VSP1900 is a CCD vertical clock driver with electric shutter. The VSP1900 is composed of five 3-state and three 2-state vertical transfer channels, which support both 3 field and 2 field CCD operation. The VSP1900 contributes low power consumption and parts number reduction in the system.

## **OPERATION**

# Power On/Off Sequence

This is the same as the CCD power up sequence, when power on, VDD powers on first VH, VM power on second, and VL powers on later. When powering off, VL powers off first, VH, VM power of second, and VDD powers off later.

#### **Vertical Transfer Signal**

The VSP1900 receives signals from TG (CCD timing generator). The input signal is converted into CCD operation voltage level by the level shifter. The level shifter circuits connect to a 2-state or 3-state driver, which is connected to the CCD input pin. While using a 2-field CCD, one of the 3-state drivers is used as a 2-state driver. The CH#N pin is pulled up internally, so that the VH level does not appear on the output pin.

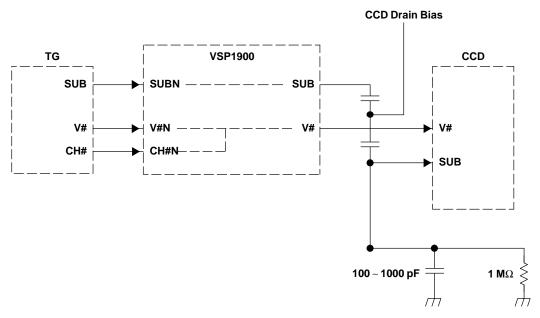


Figure 2. FVSP1900 Circuit Application

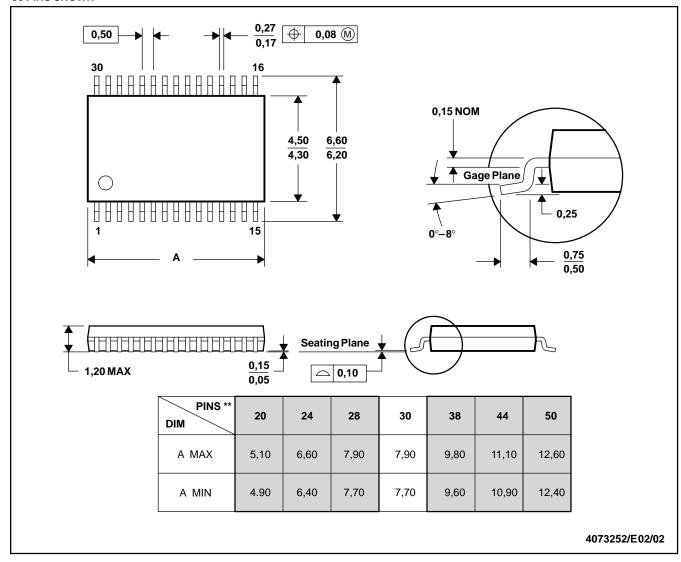


# **MECHANICAL DATA**

# DBT (R-PDSO-G\*\*)

# 30 PINS SHOWN

# PLASTIC SMALL-OUTLINE PACKAGE



- NOTES: A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion.
  - D. Falls within JEDEC MO-153



# PACKAGE OPTION ADDENDUM

30-Mar-2005

## **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
VSP1900DBT	ACTIVE	SM8	DBT	30	60	TBD	CU NIPDAU	Level-2-220C-1 YEAR
VSP1900DBTR	ACTIVE	SM8	DBT	30	2000	TBD	CU NIPDAU	Level-2-220C-1 YEAR

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

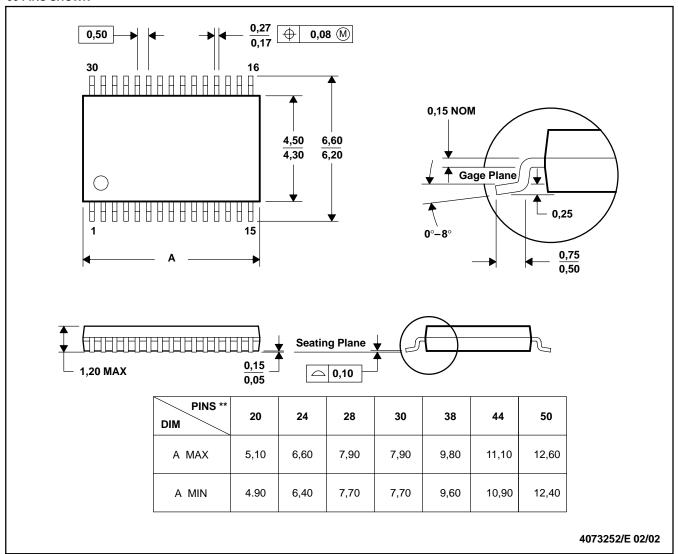
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